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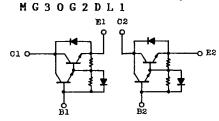
90D 16220

DT-33-35

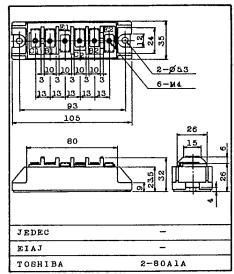


### **SEMICONDUCTOR**

TECHNICAL DATA

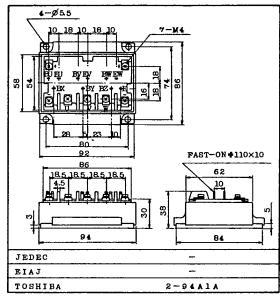


Unit in mm



Weight: 245g

MG30G6EL1



Weight: 600g

TOSHIBA CORPORATION

GT 1 A 2 A

ma Pen 18

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## SEMICONDUCTOR

TECHNICAL DATA

90D 16221 DT-33-35 .

M G 3 O G 1 B L 3
M G 3 O G 1 J L 1
M G 3 O G 2 C L 3
M G 3 O G 2 D L 1
M G 3 O G 6 E L 1

#### MAXIMUM RATINGS (Ta=25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Collector-Base Voltage		VCBO	600	v	
Collector-Emitter Sustaining Voltage		V <sub>CEX</sub> (SUS)	600	v	
Collector-Emitter Sustaining Voltage Emitter-Base Voltage		V <sub>CEO</sub> (SUS)	450	v	
		V <sub>EBO</sub>	6		
Collector Current	DC	I <sub>C</sub>	30	А	
	1ms	I <sub>CP</sub>	60	A	
Forward Current	DC	IF	30	A	
	lms	I <sub>FM</sub>	60	A	
Base Current		IB	2	A	
Collector Power Dissipation (Tc=25°C)		PC	250	W	
Junction Temperature		Tj	150	°C	
Storage Temperature Range		Tstg	-40~125	°c	
Isolatic. Voltage		V <sub>Isol</sub>	2500 (AC 1 Minute)	V	
Screw Torque (Terminal/Mounting)		_	20/30	kg · cm	

#### ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACT	ERISTIC	SYMBOL	TEST CONDITION	MIN. TY		MAX.	UNIT	
Collector Cut-o	ff Current	I <sub>CBO</sub>	V <sub>CB</sub> =600V, I <sub>E</sub> =0	-	-	1.0	mA	
Emitter Cut-off	Current	IEBO	V <sub>EB</sub> =6V, I <sub>C</sub> =0	-	-	200	mA	
Collector-Emitt Sustaining Volt		V <sub>CEO</sub> (SUS)	I <sub>C</sub> =0.5A, L=40mH	450	50		v	
DC Current Gain	-	hFE	V <sub>CE</sub> =5V, I <sub>C</sub> =30A	100	_	_		
Collector-Emitt Saturation Volt		V <sub>CE(sat)</sub>		-	-	2.0	v	
Base-Emitter Saturation Volt	age	VBE(sat)	I <sub>C</sub> =30A, I <sub>B</sub> =0.6A	-	-	2.5	v	
Switching Time	Turn-on Time	ton	INPUT OUTPUT	-	-	1.0	μs	
	Storage Time	t <sub>stg</sub>		-	-	12		
	Fall Time	tf	I <sub>B1</sub> =-I <sub>B2</sub> =Q6A V <sub>CC</sub> =300V DUTY CYCLE=Q5%	-	-	2.0		
Forward Voltage		VF	IF=30A, IB=0	-	-	1.5	V	
Reverse Recover	y Time	trr	IF=30A, VBE=-3V di/dt=100A/#s	2.0		2.0	μѕ	
Thermal Resista	overmal Productions		Transistor	-	-	0.5	°c/w	
Hermal Resistance		R <sub>th</sub> (j-c)	Diode	-	-	1.8	C/W	

TOSHIBA	CORPORATION	

GT 1 A 2 A





90D 16222

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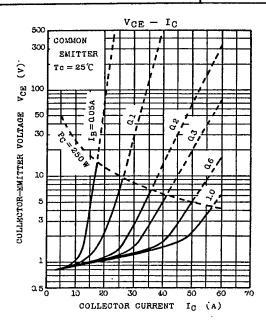
## **SEMICONDUCTOR**

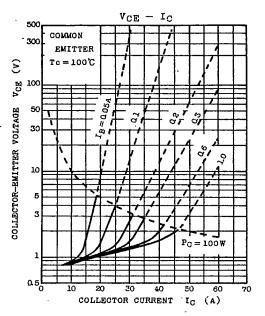
TECHNICAL DATA

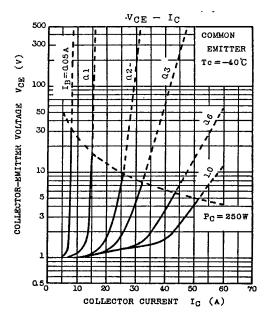
M G 3 O G 1 B L 3 M G 3 O G 1 J L 1

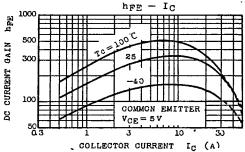
M G 3 O G 2 C L 3

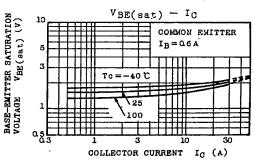
M G 3 O G 2 D L 1 - M G 3 O G 6 E L 1











TOSHIBA CORPORATION

GTIA2

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## **SEMICONDUCTOR**

TECHNICAL DATA

90D 16223

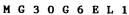
DT-33-35

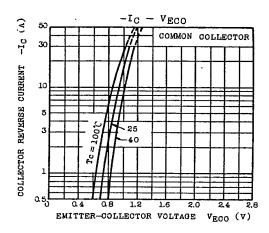
M G 3 O G 1 B L 3

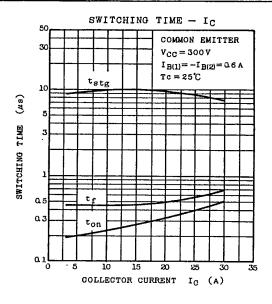
M G 3 O G 1 J L 1

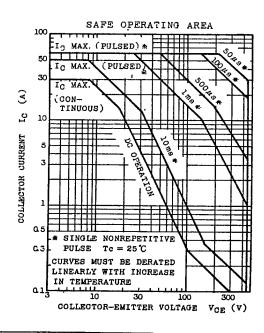
M G 3 O G 2 C L 3

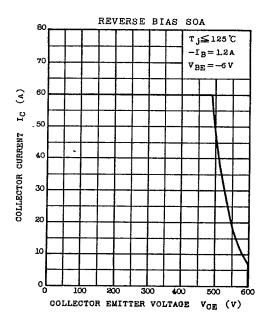
M G 3 O G 2 D L 1











TOSHIBA CORPORATION

GT IA2

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90 DE 9097250 0016224 0

9097250 TOSHIBA (DISCRETE/OPTO)



## SEMICONDUCTOR

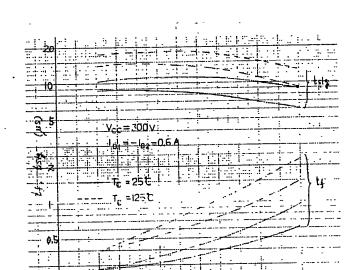
**TECHNICAL DATA** 

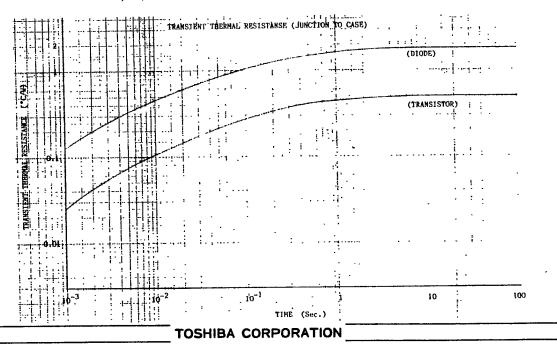
90D 16224 MG30G1BL3 MG30G1JL1 MG30G2CL3

 $M\;G\;3\;0\;G\;2\;D\;L\;1$ 

. M G 3 O G 6 E L 1

DT-33-35





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GT1A2A

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DE 9097250 0016225 2

9097250 TOSHIBA (DISCRETE/OPTO)



# **SEMICONDUCTOR**

TECHNICAL DATA

90D 16225

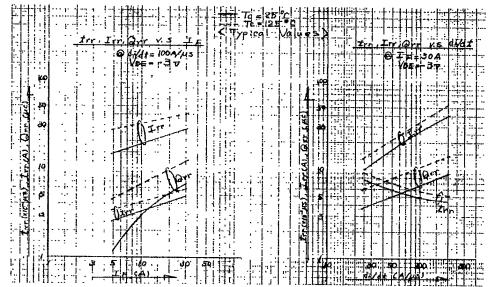
DT-33-35

MG30G1BL3 MG30G1JL1

MG30G2CL3

MG30G2DL1





**TOSHIBA CORPORATION** 

GT1A2A

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